

Multilayer Ceramic Chip Capacitor

HOLMANL - ALER - LOFINGHIAA						
Part Number:	1812YA250102	KJTSYX	Description: 1812 250Vac (Y2), 305Vac (X1), 50/60Hz / 1000Vdc 1.0nF ±10% X7R (2R1)			
Approval	IEC/EN60384-14:2013+A	1	~			
Specifications:	UL60384-14, CAN/CSA E	60384-14:14				
			T.			
Certification:	TÜV R60156291 / ID1111	239246	T			
	UL/cUL E228790-20210208					
			la la la			
Classification:	IEC/EN 60384-14:2013+A	A1 Class Y2 / X1	14			
			L2-1 - L			
	UL/cUL FOWX2, FOWX8		Component Marking and Certification Bodies:			
			Component Marking and Certification Doules.			
Material Group I	: CTI >= 600		SYX CFUBUS			
Matchar croup 1: 0112 - 000 Mechanical Specification						
Size Code 1812						
Length (L1) in mm (")			$4.95 \pm 0.35 (0.195 \pm 0.014)$			
Width (W) in mm (")			$3.2 \pm 0.30 (0.126 \pm 0.012)$			
Thickness (T) in mm (")			1.5 Max (0.06 Max)			
	Band (L2,L3) in mm (")		0.35 (0.014)			
	n Band (L2,L3) in mm (")		0.80 (0.030)			
Minimum Band Gap (4.0 (0.158)			
Termination Material			FlexiCap™ Polymer termination, Nickel barrier, Sn Plated Solder			
Solderability			(RoHS compliant) IEC-60068-2-58			
Packaging			7" Reel Horizontal Orientation, 500 per reel			
	G	eneral Electri	cal Specification			
Rated Voltage			Class Y2 (250Vac), Class X1 (305Vac), 50/60Hz, 5kV impulse			
Humidity Grade			Grade III (IEC/EN60384-14:2013 Annex 1)			
Maximum DC Working Voltage			1000Vdc certified / (2500Vdc outside scope of any specification)			
Nominal Capacitance Value			1.0nF			
Capacitance Tolerance			±10%			
Tangent of Loss Angle (Tan δ)			≤0.025			
Capacitance and Tan δ Test Conditions			1.0Vrms @ 1kHz			
Voltage Proof			100% test: 4000Vdc 1s min / 5s max			
(50mA max charging current for DC tests)			AQL test: 4000Vdc / 3000Vac 60s min / 5kV 1.2x50µs impulse			
Min Insulation Resistance (IR) Dielectric Classification			100.00GOhm @ 100Vdc X7R (2R1)			
Rated Temperature Range			-55°C / +125°C			
Maximum Capacitance Change over Temperature Range			No DC Voltage ±15%			
			Rated DC Voltage -			
Climatic Category (IEC)			55/125/56			
Ageing Characteristic			<2% per decade			
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USA: KPD-NA-sales@knowles.com any form or c		any form or disclosed to a	or disclosed to a third party without the consent			
www.knowle	scapacitors.com	specification.	tomer mentioned within this Date: Thursday, September 02, 2021 20210902 193957047UTC			



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Environmental							
RoHS Compliant to 2011/65/EC as amended by 2015/863/EU Compliant							
REACH Compliant		211 compliant					
California Proposition 65		No exposure risk					
Board Layout							
Knowles' conventional 2-terminal chip generally be mounted using pad designs i international specification IPC-7351, Gen for Surface Mount Design and Land Patter there are some other factors that have bee mechanical stress, such as reducing the than the chip width. In addition, the position board should be considered. Some high voltage parts may require m board layout and/or the addition of a co prevent flashover. Refer to application further information.	n accordance with eric Requirements ern Standards, but n shown to reduce pad width to less n of the chip on the odifications to the nformal coating to		IPC-7351 pad design 1812 C 5.35mm 0.211" Y 1.25mm 0.049" X 3.40mm 0.134" 1 1 1 1 1 1 1 1				
Packaging							
Tape packaging information for tape-ar Tape and reel packing of surface mour capacitors for automatic placement are with IEC60286-3.	ting chip		Product identifying label Plastic carrier tape Top tape 8 or 12mm 178mm (7") or nominal 330mm (13") dia. reel				
Soldering							
Reflow solder in accordance with IPC- Recommended reflow profile as laid do IPC/JEDEC J-STD-020. Wave soldering is also possible, but ca taken for case sizes 1210 and larger a thickness >1.0mm. Trials are encourage Hand soldering is not recommended an component damage through thermal solution	own in are must be nd component ged. nd can lead to	Temperature	T _p T _L T _L Max Min t t t T _L Preheat area Time				
Application notes with mounting and handling guidance are available on request.							
	Johanson MFG	Novacap	Syfer Voltronics				
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